



ADDITIONAL 3D BGA STEREO VISION PATENT AWARDED

Friday July 7, 2000, 1:00 pm Eastern Time

Elwin M. Beaty, President of Scanner Technologies Corporation, announced today the award of patent number 6,072,898 for its 3D BGA stereo vision inspection equipment. This patent adds to Scanner's portfolio of stereo vision patents for the 3D inspection of BGA, CSP and bump on wafer products. Mr. Beaty stated that the recent awards of patents for stereo vision inspection of ball and bump devices further strengthen Scanner's position as the world leader in 3D vision inspection technology.